SPECIFICATIONS					
CUSTOMER	:				
SAMPLE CODE	SH192108T005-ZFC				
MASS PRODUCTION CODE	PH192108T005-ZFC				
SAMPLE VERSION	. 01				
SPECIFICATIONS EDITION	. 003				
DRAWING NO. (Ver.)	LMD-PH192108T005-ZFC(Ver.004)				
PACKAGING NO. (Ver.)	PKG-PH192108T005-ZFC(Ver.001)				

Date:

Approved	Checked	Designer
林裘中	呂清溪	王靖維
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☐ Preliminary specification for design input

Specification for sample approval

2022.08.10 TW RD APR

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
12/28/2021	01	001	New Drawing	-	Yuting
05/24/2022	01	002	First sample Update 1.5 Optical Characteristics Update Operating/Storage Temperature Add/Modify CTP Control Board Pin define	5, 6, 13, Appendix	Yuting
08/09/2022	01	003	Update 1.5 Optical Characteristics Update Touch IC : ILI2521 Update CTP Control Board	4, 6, 10, 11,13, Appendix	Jack



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Appendix: 1. LCM Drawing.

2. Packaging



1. SPECIFICATIONS

1.1 Features

Item	Standard Value				
Screen Size (Inch)	15.6" (Diagonal)				
Resolution	1920* (R · G · B) * 1080 Dots				
Display Mode	Transmissive, Normally Black				
Display Colors	16.2M				
Display Interface	Dual-Channel LVDS, 4-lane per Channel				
Touch type	Projective capacitive touch panel				
Touch Method	Finger / 10 Points touch				
Touch Interface	USB				
Touch IC	ILI2521				
	THIS PRODUCT CONFORMS THE ROHS OF PTC				
ROHS	Detail information please refer website:				
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1				

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	385.16(W) * 234.59 (L) * 18.0 (H)Max	mm

LCD panel

Item	Standard Value	Unit
Active Area	344.16 (W) * 193.59 (L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute ratings of environment

Item	Symbol	Condition	Min.	Max.	Unit
Operating Temperature	T _{OP}	-	-30	+85	$^{\circ}\!\mathbb{C}$
Storage Temperature	T _{ST}	-	-40	+90	$^{\circ}\!\mathbb{C}$
Storage Humidity	H _D	Ta<60 ℃	A	90	%RH

1.4 TFT LCD Characteristics

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage for TFT LCD Module	Vcc		-0.3	+4.0	V
Logic Input Voltage for TFT LCD Module	V _{IN}		-0.3	+4.0	V

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

LCD ELETRONICS SPECIFICATION

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power Supply Voltage	Vcc	3.15	3.3	3.6	V	
Ripple Voltage	V _{RP}	-	-	150	mV	
Rush Current	IRUSH	-	-	3	Α	
Power Supply Current	-	-	1.22	1.5	Α	
Power Consumption	PLCD	-	4	5	Watt	



1.5 Optical Characteristics

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	-
Response time		T _r + T _f	-	-	25	35	ms	Note2
	Тор	ΘΥ+		85	89	-		
Viowing angle	Bottom	ΘΥ-	CR ≥ 10	85	89	-	Dog	Note4
Viewing angle	Left	ΘХ-	CK 2 10	85	89	-	Deg.	NOIE4
	Right	ΘХ+		85	89	1		
Contrast ratio)	CR		600	800	-	·	Note3
	White	Χ	Ta = 25°C		0.30	Тур +0.05		
	vviile	Υ			0.33		-	
0 1 (0)5	Red	Х			0.65			
Color of CIE	Reu	Υ		Тур	0.34			N
Coordinate (With B/L and TP)	Green	Х	ΘX , ΘY = 0°	-0.05	0.32			Note1
(With B/E and 11)	Green	Υ			0.61			
	Blue	Х			0.13	P		
	Diue	Υ			0.05			
Average Brightness								
Pattern=white display		IV	-	300	380	-	cd/m2	Note1
(With TP)								
Uniformity (With TP) *2		ΔΒ	-	70	-	-	%	Note1



Note1:

 $1 : \triangle B=B(min) / B(max) \times 100\%$

2 : Measurement Condition for Optical Characteristics:

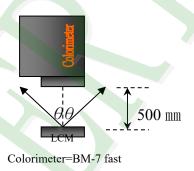
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

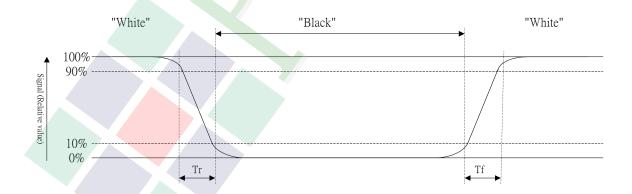
d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes. Refer to figure as below:





Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

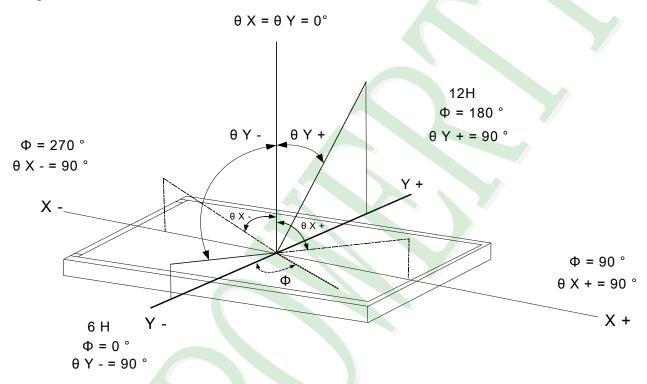
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Absolute Maximum Ratings

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Converter Voltage	LED_V _{in}	0	12.0	18.0	V	(1), (2)
Enable Voltage	LED_EN	0	3.3	7	V	Duty=100%
Backlight Adjust	LED_PWM	0	3.3	7	V	(1), (2) Pulse Width≦10msec. And Duty≦10%

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation

Electrical Characteristics

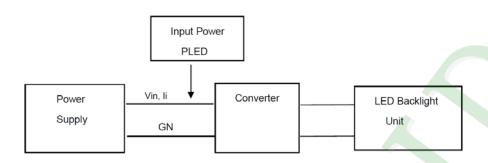
Item	Symbol	Min.	Тур.	Max.	Unit	Note
Converter Power Supply Voltage	LED_Vin	10.8	12.0	13.2	V	
Converter Power Supply Current	li	0.8	1.0	1.2	Α	@LED_Vin=12
Converter Fower Supply Current	"	0.6	1.0	1.2	^	Duty=100%
Converter Input Rush Current	lirsh		1	3	Α	@LED_Vin rising
Converter input Rush Current	111511			3	^	=1ms
Power Consumption	PLED		12		W	@LED_Vin=12
rower Consumption	PLED		12	_	VV	Duty=100%
EN Control Level	LED_EN	2.0	5	5.5	V	
PWM Control Level	LED_PWM	2.0	3.3	5.0	V	
PWM Control Duty Ratio	-	10	-	100	%	
PWM Control Frequency	fрwм	190	200	20k	Hz	
LED Life Time	Lı	50,000	-	-	Hrs	(2)

Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

Note (2) The lifetime of LED is estimated data and defined as the time when it continues to operate under the conditions at Ta = 25±2°C and Duty 100% until the brightness becomes ≤ 50% of its original value. Operating LED under high temperature environment will reduce life time and lead to color shift.

Note (2) Specified values are for input pin of LED light bar at Ta=25±2 °C





1.7 Touch Panel Characteristics

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	VDD		-	+6.0	V

Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage for USB	VBUS	i		5.0	1	V

Optical Characteristics

Item	Standard Value	Unit
Total light transmittance	85% or more	-
Hardness	≥7H	



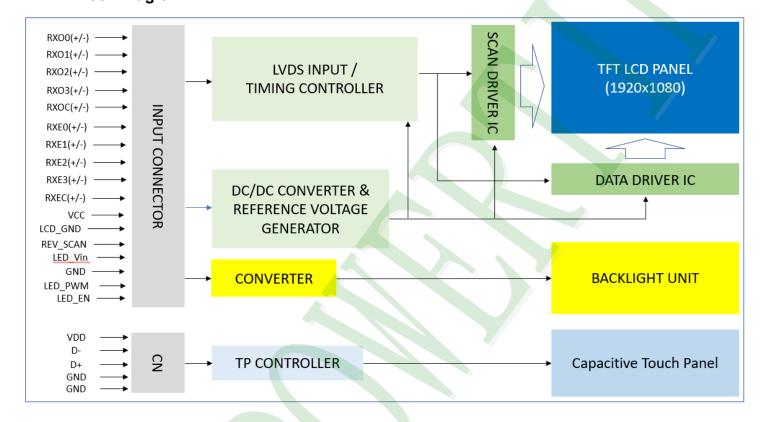
2. MODULE STRUCTURE

2.1 Counter Drawing

LCM Mechanical Diagram

* See Appendix

Block Diagram





2.2 Interface Pin Description

• LCM

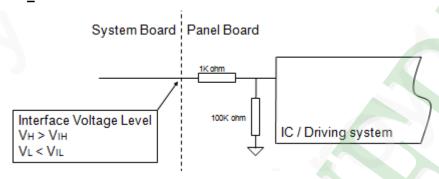
Pin No.	Symbol	Description	Note			
1	LED_Vin	+12V Power Supply.				
2	LED_Vin	+12V Power Supply.				
3	LED_Vin	+12V Power Supply.				
4	LED_Vin	+12V Power Supply.				
5	GND	Ground				
6	GND	Ground				
7	GND	Ground				
8	GND	Ground				
9	LED_EN	LED Backlight Enable Input.				
10	LED_PWM	LED Backlight PWM Control Signal for Dimming.				
11	VCC	LCD Logic and Driver Power 3.3V				
12	VCC	LCD Logic and Driver Power 3.3V				
13	VCC	LCD Logic and Driver Power 3.3V				
14	NC	Not connection, this pin should be open				
15	NC	Not connection, this pin should be open				
16	NC	Not connection, this pin should be open				
17	REV_SCAN	Low or NC → Normal Mode.				
17	NEV_OOAN	High → Horizontal & Vertical Reverse Scan	(1)			
18	RXO0-	Negative LVDS differential data input. Channel O0 (odd)				
19	RXO0+	Positive LVDS differential data input. Channel O0 (odd)				
20	RXO1-	Negative LVDS differential data input. Channel O1 (odd)				
21	RXO1+	Positive LVDS differential data input. Channel O1 (odd)				
22	RXO2-	Negative LVDS differential data input. Channel O2 (odd)				
23	RXO2+	Positive LVDS differential data input. Channel O2 (odd)				
24	LCD_GND	LCD logic and driver ground				
25	RXOC-	Negative LVDS differential clock input. (odd)				
26	RXOC+	Positive LVDS differential clock input. (odd)				
27	LCD_GND	LCD logic and driver ground				
28	RXO3-	Negative LVDS differential data input. Channel O3(odd)				
29	RXO3+	Positive LVDS differential data input. Channel O3 (odd)				
30	RXE0-	Negative LVDS differential data input. Channel E0 (even)				
31	RXE0+	Positive LVDS differential data input. Channel E0 (even)				
32	RXE1-	Negative LVDS differential data input. Channel E1 (even)				
33	RXE1+	Positive LVDS differential data input. Channel E1 (even)				



34	LCD_GND	LCD logic and driver ground
35	RXE2-	Negative LVDS differential data input. Channel E2 (even)
36	RXE2+	Positive LVDS differential data input. Channel E2 (even)
37	RXEC-	Negative LVDS differential clock input. (even)
38	RXEC+	Positive LVDS differential clock input. (even)
39	RXE3-	Negative LVDS differential data input. Channel E3 (even)
40	RXE3+	Positive LVDS differential data input. Channel E3 (even)

Note (1) "Low" stands for 0V. "High" stands for 3.3V. "NC" stands for "No Connected".

REV_SCAN PIN:



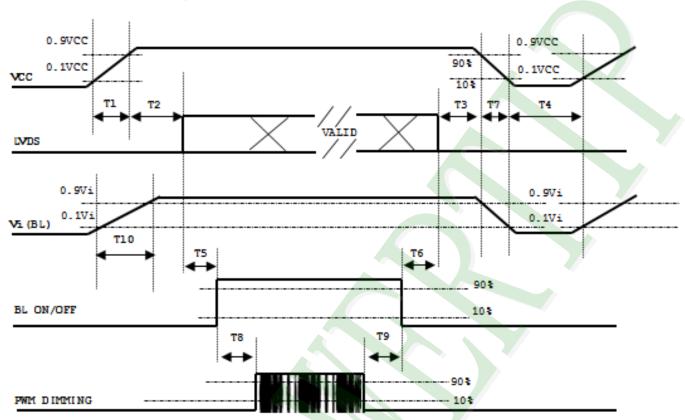
J3 - Capacitive Touch Panel (CTP) Interface

Pin No.	Symbol	Description
1	VDD	Power Supply. (+5.0V)
2	D-	D- Differential Data Input.
3	D+	D+ Differential Data Input.
4	GND	Ground.
5	GND	Ground.



2.3 Power Supply Characteristics

POWER ON/OFF SEQUENCE



Timing Specifications:

Item	Min.	Тур.	Max.	Units
T1	0.5		10	ms
T2	0	-	50	ms
T3	0	-	50	ms
T4	500	-	-	ms
T5	450	-	-	ms
T6	200	ı	-	ms
T7	10	ı	100	ms
T8	10	-	-	ms
T9	10	-	-	ms
T10	20	-	50	ms



2.4 Timing Characteristics

LVDS DATA MAPPING TABLE

LVDS Channel O0	LVDS output	D7	D6	D4	D3	D2	D1	D0
LVD3 Channel O0	Data order	OG0	OR5	OR4	OR3	OR2	OR1	OR0
LVDS Channel O1	LVDS output	D18	D15	D14	D13	D12	D9	D8
LVD3 Channel O1	Data order	OB1	OB0	OG5	OG4	OG3	OG2	OG1
LVDS Channel O2	LVDS output	D26	D25	D24	D22	D21	D20	D19
LVDS Channel 02	Data order	DE	NA	NA	OB5	OB4	OB3	OB2
LVDS Channel O3	LVDS output	D23	D17	D16	D11	D10	D5	D27
LVD3 Channel O3	Data order	NA	OB7	OB6	OG7	OG6	OR7	OR6
LVDS Channel E0	LVDS output	D7	D6	D4	D3	D2	D1	D0
	Data order	EG0	ER5	ER4	ER3	ER2	ER1	ER0
LVDS Channel E1	LVDS output	D18	D15	D14	D13	D12	D9	D8
	Data order	EB1	EB0	EG5	EG4	EG3	EG2	EG1
LVDS Channel E2	LVDS output	D26	D25	D24	D22	D21	D20	D19
	Data order	DE	NA	NA	EB5	EB4	EB3	EB2
LVDS Channel E3	LVDS output	D23	D17	D16	D11	D10	D5	D27
	Data order	NA	EB7	EB6	EG7	EG6	ER7	ER6

DISPLAY TIMING SPECIFICATIONS

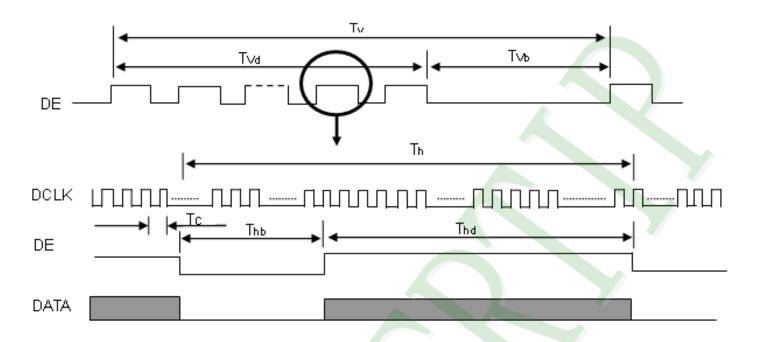
Signal	Item	Symbol	Min.	Тур.	Max	Unit	Note
	Frequency	Fc	60	70.93	75	MHz	-
	Period	Tc		14.1	-	ns	
	Input cycle to cycle jitter	Trcl	-0.02* T _C		0.02* Tc	ns	(3)
LVDS Clock	Input clock to data skew	TLVCCS	-0.02* T _C	1	0.02* T _C	ns	(4)
CIOCK	Spread spectrum modulation range	Fclkin_mod	Fc*98%	ı	Fc*102%	MHz	
	Spread spectrum modulation frequency	Fssm	-	-	200	KHz	(5)
Vertical	Frame	Fr	50	60	60	Hz	Tv=Tvd+Tvb
Vertical	Total	Tv	1090	1110	1130	Th	-
Display Term	Active Display	Tvd	1080	1080	1080	Th	-
Tellii	Blank	Tvb	Tv-Tvd	30	Tv-Tvd	Th	-
Horizontal	Total	Th	1050	1065	1075	Тс	Th=Thd+Thb
Display	Active Display	Thd	960	960	960	Тс	-
Term	Blank	Thb	Th-Thd	105	Th-Thd	Тс	-

Because this module is operated by DE only mode, Hsync and Vsync input signals are ignored. The Tv (Tvd+Tvb) must be integer, otherwise, this module would operate abnormally. Note (1)

Note (2)

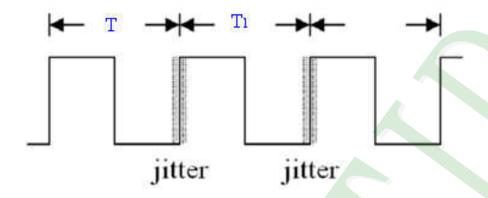


INPUT SIGNAL TIMING DIAGRAM

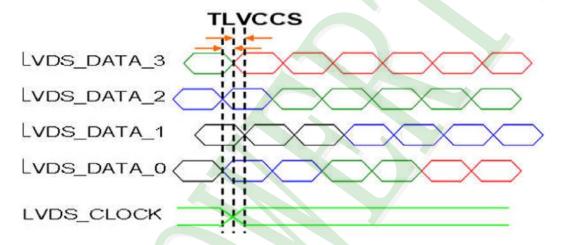




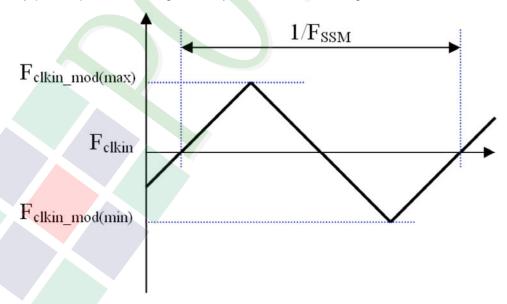
Note (3) The input clock cycle-to-cycle jitter is defined as below figures. Trcl = I T1 – TI



Note (4) Input Clock to data skew is defined as below figures.



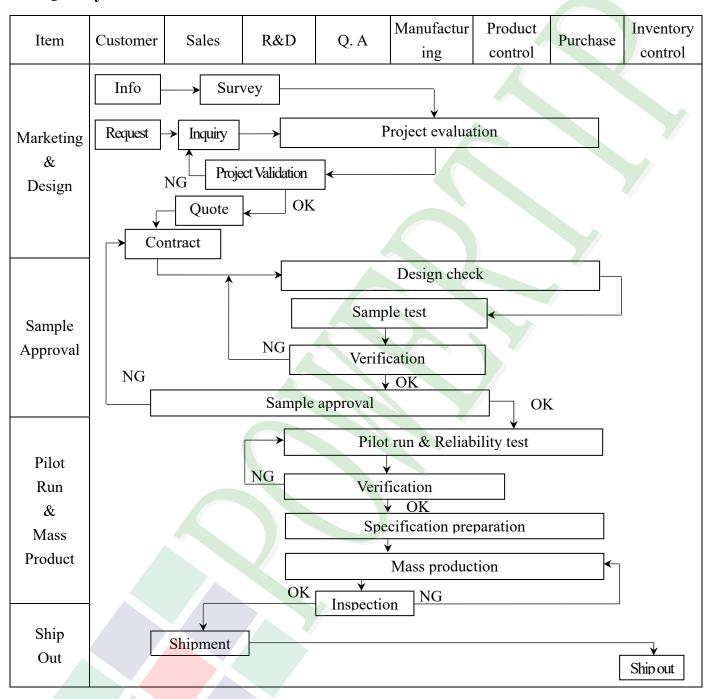
Note (5) The SSCG (Spread spectrum clock generator) is defined as below figures.



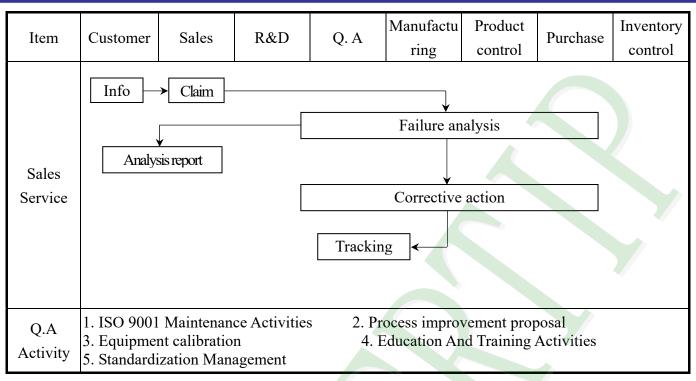


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3.5" ~15" (Ver.B01).

♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

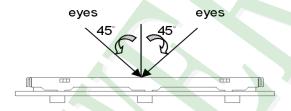
◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

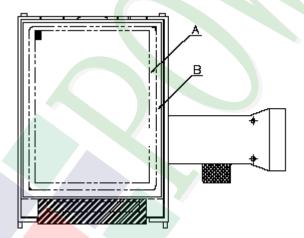
♦Standard of the product appearance test:

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is based on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level			
		1.1The part number is inconsistent with work order of production.				
01	Product condition	1.2 Mixed product types.				
		1.3 Assembled in inverse direction.				
02	Quantity	2.1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3.1Product dimension and structure must conform to structure diagram.	Major			
		4.1 Missing line character and icon.	Major			
		4.2 No function or no display.	Major			
		4.3 Display malfunction.				
04	Electrical Testing	4.4 LCD viewing angle defect.				
		4.5 Current consumption exceeds product specifications.				
		4.6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.				
05	Dot defect (Bright dot, Dark dot) On -display	Bright Dot ≤ 4 Dot Dark Dot ≤ 5 Defect Joint Dot ≤ 3 Total ≤ 7				



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO NO	Item	Criterion	Ver.B01) Level
110	100111	6. 1 Round type (Non-display or display) :	Level
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area	
	Black or white	$ \Phi \leq 0.25 \qquad \text{Ignore} \\ 0.25 < \Phi \leq 0.50 \qquad 5 $	
	dot \ scratch \ contamination	$\Phi > 0.50$ Ignore	
	Round type	Total 5 6. 2 Line type(Non-display or display) :	
	$\begin{array}{c c} & & \\ \hline & & \\ \hline & & \\ \hline & & \\ \hline \end{array}$	Langth Accentance (O'ty)	
06		module size (L) Width (W) A area (U) B area (U) $(U$	Minor
	$\Phi = (x+y)/2$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
	Line type	$ \qquad \qquad W > 0.10 \qquad \begin{array}{c} As \ round \\ type \end{array}$	
	→ I I I I I I I I I I I I I I I I I I I	Total 5 $ \qquad W \leq 0.05 \qquad \text{Ignore}$ $L \leq 10.0 0.05 \langle W \leq 0.10 5 \rangle$	
	L	9" to 15" $L \le 10.0 0.05 < W \le 0.10 5 W > 0.10 As round type Ignore$	
		Total 5	
		Dimension (diameter : Φ)	
		$\Phi \leq 0.25$ Ignore	
07	Polarizer Bubble	$0.25 < \Phi \leq 0.50 \qquad \qquad 4$	Mino
		$0.50 < \Phi \le 0.80$ 1 Ignore $\Phi > 0.80$ 0	
		Total 5	



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level
		Z: The thickness of crack W: teri	e width of crack. minal length D side length
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack be	etween panels:
08	The crack of glass	SP Z Y [OK]	Y X Minor [NG]
		Seal width Z	Y
		X Y ≤ a Crack can't enter	Z ≤1/2 t
		viewing area ≤ a Crack can't exceed the half of SP width. 1/2	$t < Z \leq 2 t$



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass Y: The width of crack. W: terminal length a: LCD side length	
		8.1.2 Corner crack:	
		X Y Z	
		≤1/5 a Crack can't enter viewing area $ Z ≤ 1/2 t$	
		$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2 t	
08	The crack of glass		 Minor
00	The crack of glass	8.2 Protrusion over terminal:	Willion
		8. 2. 1 Chip on electrode pad:	
		X	
		$ \begin{array}{c cccc} X & Y & Z \\ \hline Front & \leq a & \leq 1/2 W & \leq t \\ \end{array} $	
		Back $\leq a$ $\leq 1/2$ W $\leq t$ $\leq 1/2$ t	



◆Specification For TFT-LCD Module 3. 5″ ~15″:



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
10	General appearance	10. 1 Pin type \quantity \dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	Major
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤ 1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

	4.1 Reliability Test Collation				
NO.	TEST ITEM	TEST CONDITION			
1	High Temperature Operation Test	Keep in +85 ±2℃ 240 hrs, Display ON Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Operation Test	Keep in -30 ±2℃ 240 hrs, Display ON Surrounding temperature, then storage at normal condition 4hrs.			
3	High Temperature Storage Test	Keep in +90 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.			
4	Low Temperature Storage Test	Keep in -40 ±2℃ 240 hrs Surrounding temperature, then storage at normal condition 4hrs.			
5	High Temperature / High Humidity Storage Test	Keep in +60℃ / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)			
6	Temperature Cycling Storage Test	-40°C → +25°C → +90°C → +25°C (30mins) (5mins) (30mins) (5mins) 20 Cycle Surrounding temperature, then storage at normal condition 4hrs.			
7	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonic solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and $3 \sim 5$ sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution! (LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SPS) can lead to touch malfunction (e.g., ghost-touches). Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attached with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-side tape for the attachment operation.

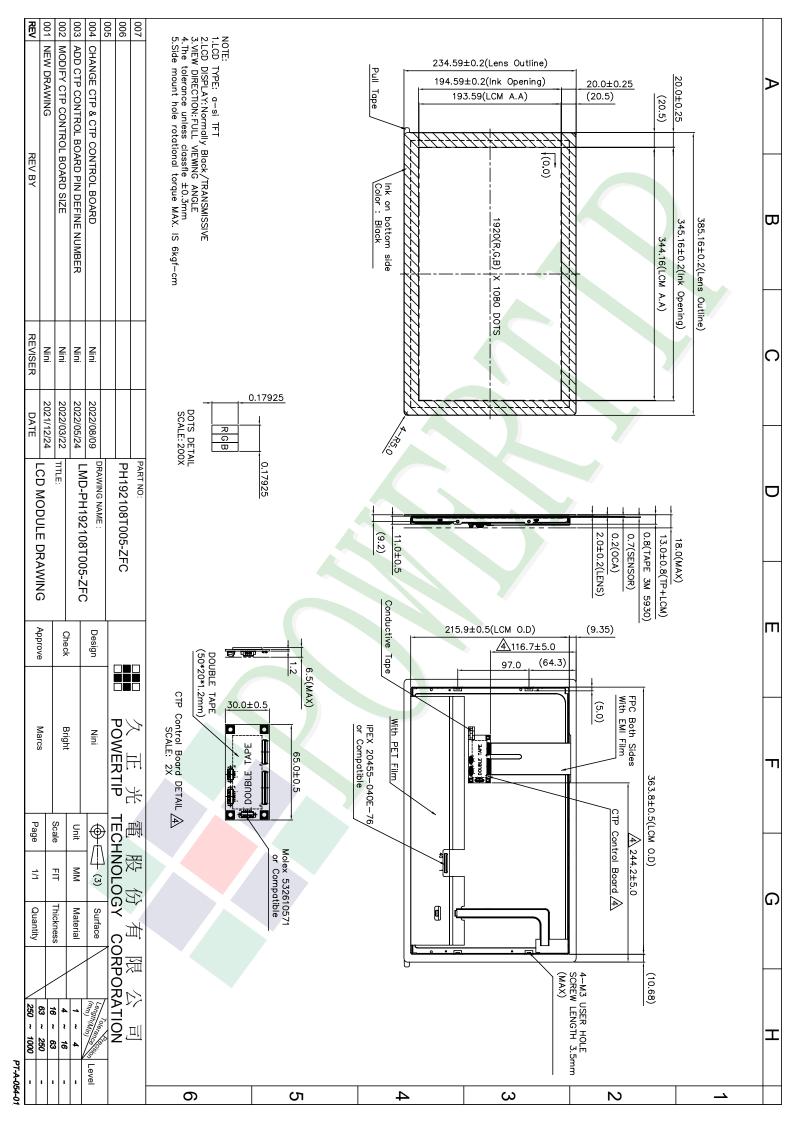
5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period

 The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Marcs **Bright** Nini Documents NO. PKG-PH192108T005-ZFC 1.包裝材料規格表 (Packaging Material): (per carton) Dimensions (mm) Total Weight No. Model 1Pcs Weight Quantity 1 模組 (LCM) PH192108T005-ZFC 385.16 X 234.56 X 17.5 120 204 1.7 2 抗靜電袋(1)Antistatic Bag 120 BAG000000053 350 X 450 0.02 2.4 3 舒美墊(2) EPE 30 460 X 335 X 20 0.05 1.5 FOAM00000280 4 舒美墊(3) EPE 120 FOAM00000279 460 X 335 X 40 0.11 13.2 30 5 舒美墊(4) EPE FOAM00000281 460 X 335 X 15 0.075 2.25 6 外紙箱(5)Carton 473X 345 X 240 30 BX47334524CCBA 1.0 30.0 7 棧板(6)PALLET 1200 X 1000 X 140 OTPALLET005ABA 8.0 8.0 1 8 2. 整箱總重量 (Total LCD Weight in carton): 261.35 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity in carton: quantity per EPE x no of carton 4 (2)Total LCM quantity in pallet: quantity per carton x no. of cartons 30 120 (2)EPE (1)靜電袋+LCM (5)外紙箱 Antistatic Bag+LCM Carton (3)EPE (6) 棧板 **PALLET** (4)EPE 特 記 事 項 (REMARK) 4.外箱擺放方式:一層擺放6箱外箱, 共5層。 6箱 X 5層 =30箱外箱 5.不滿一棧板之尾數箱,需用棧板出貨。 6.外圍加打包帶及外部封塑膠膜。